### **General Specifications**





#### **GENERAL DESCRIPTION**

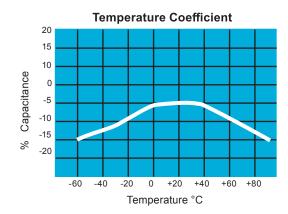
- · General Purpose Dielectric for Ceramic Capacitors
- EIA Class II Dielectric
- Temperature variation of capacitance is within ±15% from -55°C to +85°C
- Well suited for decoupling and filtering applications
- Available in High Capacitance values (up to 100μF)

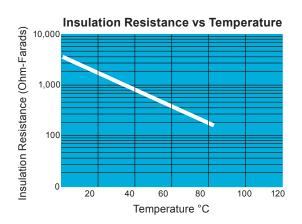
### PART NUMBER (SEE PAGE 4 FOR COMPLETE PART NUMBER EXPLANATION)

1210	4	D	107	M	Α	T	2	Α
	T	T	T	T	T	T	T	T
Size	Voltage	Dielectric	Capacitance	Capacitance	Failure	Terminations	Packaging	Special
(L" x W")	4 = 4V	D = X5R	Code (In pF)	Tolerance	Rate	T = Plated Ni	2 = 7" Reel	Code
0101**	6 = 6.3V		2 Sig. Digits +	$K = \pm 10\%$	A = N/A	and Sn	4 = 13" Reel	A = Std.
0201	Z = 10V		Number of	$M = \pm 20\%$				
0402	Y = 16V		Zeros					
0603	3 = 25V							
0805	D = 35V							<b>A</b> A
1206	5 = 50V							
1210	1 = 100V							The same of the sa
1812								
**EIA 010	005							RoHS
								COMPLIANT

NOTE: Contact factory for availability of Tolerance Options for Specific Part Numbers. Contact factory for non-specified capacitance values.

### TYPICAL ELECTRICAL CHARACTERISTICS









Parame	ter/Test	X5R Specification Limits	Measuring C	Conditions					
Operating Tem	perature Range	-55°C to +85°C	Temperature Cy	cle Chamber					
Capac	itance	Within specified tolerance							
Dissipation	on Factor	≤ 2.5% for ≥ 50V DC rating ≤ 12.5% for 25V, 35V DC rating ≤ 12.5% Max. for 16V DC rating and lower Contact Factory for DF by PN	Freq.: 1.0 kHz ± 10% Voltage: 1.0Vrms ± .2V For Cap > 10 µF, 0.5Vrms @ 120Hz						
Insulation	Resistance	10,000MΩ or 500MΩ - μF, whichever is less	Charge device with rated voltage for 120 ± 5 secs @ room temp/humidity						
Dielectric	: Strength	No breakdown or visual defects	Charge device with 250% of rated voltage for 1-5 seconds, w/charge and discharge current limited to 50 mA (max)						
	Appearance	No defects	Deflection	n: 2mm					
Resistance to	Capacitance Variation	≤ ±12%	Test Time: 3						
Flexure Stresses	Dissipation Factor	Meets Initial Values (As Above)	V						
Insulation Resistance		≥ Initial Value x 0.3	90 m	nm ————					
Solder	ability	≥ 95% of each terminal should be covered with fresh solder	Dip device in eutectic sole ± 0.5 sec						
	Appearance	No defects, <25% leaching of either end terminal							
	Capacitance Variation	≤ ±7.5%							
Resistance to Solder Heat	Dissipation Factor	Meets Initial Values (As Above)	Dip device in eutectic 60seconds. Store at roor	n temperature for 24 ±					
	Insulation Resistance	Meets Initial Values (As Above)	2hours before measuring	g electrical properties.					
	Dielectric Strength	Meets Initial Values (As Above)							
	Appearance	No visual defects	Step 1: -55°C ± 2°	30 ± 3 minutes					
	Capacitance Variation	≤ ±7.5%	Step 2: Room Temp	≤ 3 minutes					
Thermal Shock	Dissipation Factor	Meets Initial Values (As Above)	Step 3: +85°C ± 2°	30 ± 3 minutes					
	Insulation Resistance	Meets Initial Values (As Above)	Step 4: Room Temp ≤ 3 minutes						
	Dielectric Strength	Meets Initial Values (As Above)	Repeat for 5 cycles and measure after 24 ± 2 hours at room temperature						
	Appearance	No visual defects	Charge device with 1.5	rated voltage in test					
	Capacitance Variation	≤ ±12.5%	chamber set at 85°C ± (+48,	2°C for 1000 hours					
Load Life	Dissipation Factor	≤ Initial Value x 2.0 (See Above)	Note: Contact factory for part numbers that are t						
	Insulation Resistance	≥ Initial Value x 0.3 (See Above)	volta						
	Dielectric Strength	Meets Initial Values (As Above)	Remove from test chamber temperature for						
	Appearance	No visual defects							
	Capacitance Variation	≤ ±12.5%	Store in a test chamber se 5% relative humidity for 10						
Load Humidity	Dissipation Factor	≤ Initial Value x 2.0 (See Above)	rated voltag	e applied.					
			Remove from chamber and stabilize at room temperature and humidity for						
Trummunty	Insulation Resistance	≥ Initial Value x 0.3 (See Above)		d humidity for					





### **PREFERRED SIZES ARE SHADED**

Case Size	Case Size 0101* 0201								0402						0603						0805							
Soldering			v Only			flow 0	nlv		Reflow/Wave					Reflow/Wfeve						Reflow/Wfeve								
Packaging		Paper/Er				II Pap						aper			All Paper					Paper/Embossed								
(L) Length	mm (in.)	0.40 : (0.016 ±	± 0.02		0.6	60 ± 0. 24 ± 0.	.09		1.00 ± 0.20 (0.040 ± 0.008)					1.60 ± 0.20 (0.063 ± 0.008)						2.01 ± 0.20 (0.079 ± 0.008)								
W) Width	mm (in.)	0.20 : (0.008 ±				30 ± 0. 11 ± 0.				0.50 ± 0.20 (0.020 ± 0.008)					0.80 ± 0.20 (0.031 ± 0.008)						1.25 ± 0.20 (0.049 ± 0.008)							
(t) Terminal	mm (in.)		$0.10 \pm 0.04$ $0.15 \pm 0.05$ $(0.004 \pm 0.0016)$ $(0.006 \pm 0.002)$									± 0.10 ± 0.00			0.35 ± 0.15 (0.014 ± 0.006)										50 ± 0 20 ± 0			
Voltage:		6.3	10	4	6.3	10	16	25	4	6.3	10	16	25	50	4	6.3	10	16	25	35	50	4	6.3	10	16	25	35	50
Cap (pF) 100	101		В					Α																				
150	151		В					Α																				
220	221		В					Α						С														
330	331		В					Α						С														
470	471		В					Α						С														
680	681		В					Α						С														
1000	102		В				Α	Α						С														
1500	152	В	В				Α	Α						С														
2200	222	В	В			Α	Α	Α						С														
3300	332	В	В			Α	Α	Α						С														
4700	472	В	В			Α	Α	Α					С								G							
6800	682	В	В			Α	Α	Α					С								G							
Cap (µF) 0.01	103	В	В			Α	Α	Α					С						G	G	G							
0.015	150	В											С						G	G	G							
0.022	223	В			Α	Α	Α	Α				С	С						G	G	G							N
0.033	333	В										С							G	G	G							N
0.047	473	В			Α	Α	Α	Α				С	С						G	G	G							N
0.068	689	В										С					ļ		G		G				ļ			N
0.1	104	В			Α	Α	Α	Α			С	С	С	C					G	G	G					N	N	N
0.15	154																ļ		G						ļ	N	N	
0.22	224	В		Α	Α	Α				С	С	С	С	С				G	G							N	N	N
0.33	334	_				_								_			_	G	G						_	N		
0.47	474	В		Α	Α			ļ	С	С	С	С	С	E		<u> </u>	ļ	G	J				<u> </u>		ļ	N	Р	P
0.68	684							_								-		G					-	<u> </u>		N	_	_
1.0	105			Α	Α	С	С		С	С	С	С	С		G	G	G	G	J	G	G				N	N	Р	Р
1.5	155			_				-						_						1/	1/		-	N.	-	_	_	<u> </u>
2.2	225			С	С	С		-	С	С	С	С	С		G	G	J	J	J	K	K		L	N	N	Р	Р	P
3.3	335			0	_			-					-	_	J	J	J	J	1/		<u> </u>	N.	N	N	- NI	NI.	_ D	- D
4.7	475			С	С				E	E	E	Е	-	<u> </u>	J	J	J	G	K		_	N P	P	J P	N	N P	Р	P
10	106				-	-		-	E	E	E	<u> </u>	-	-	K	J	K	K	K		<u> </u>	P	P	P	P P	ļР P	-	$\vdash$
22 47	226 476				-			-	Е	G		-	-	<u> </u>	K	K	K					P	P	P	Р	P		$\vdash$
100	4/6 107				-	-		-	<u> </u>	-	-	<u> </u>	-	-	K	K	-	_	-		<u> </u>	Р	Р	Р	-	_	-	$\vdash$
Voltage:	10/	6.3	10	4	6.3	10	16	25	4	6.3	10	16	25	50	1	6.2	10	16	25	25	50	1	6.2	10	16	25	25	50
Case Size				4	0.3	0201	10	23	4	0.3		02	25	50	4   6.3   10   16   25   35   50 0603					4   6.3   10   16   25   35   50   <b>0805</b>								
Case Size 0101* 0201									04	υZ						0003							0000					

Letter	Α	В	С	E	G	J	K	М	N	Р	Q	Х	Υ	Z
Max. Thickness	0.33 (0.013)	0.22 (0.009)	0.56 (0.022)	0.71 (0.028)	0.90 (0.035)	0.94 (0.037)	1.02 (0.040)	1.27 (0.050)	1.40 (0.055)	1.52 (0.060)	1.78 (0.070)	2.29 (0.090)	2.54 (0.100)	2.79 (0.110)
			PAI	PER						EMBO	SSED			

PAPER and EMBOSSED available for 01005 NOTE: Contact factory for non-specified capacitance values \*EIA 01005





### **PREFERRED SIZES ARE SHADED**

Case Size					1206							1210				1812									
Soldering				Refl	ow/W	/ave			Reflow Only							Reflow Only									
Packaging				Paper	/Emb	ossec	<u> </u>		Paper/Embossed							All Embossed									
(L) Length	mm		-		20 ± 0.				3.20 ± 0.40							4.50 ± 0.30									
(L) Length	(in.)				26 ± 0.				(0.126 ± 0.016)								(0.177 ± 0.012)								
W) Width	mm				0 ± 0.					2.50 ± 0.30							3.20 ± 0.20								
	(in.)				3 ± 0							98 ± 0							26 ± 0.						
(t) Terminal	mm				50 ± 0.							50 ± 0.				0.61 ± 0.36 (0.024 ± 0.014)									
	(in.)				20 ± 0.		0.5		_			20 ± 0		0.5							٥٢				
Voltage:	101	4	6.3	10	16	25	35	50	4	6.3	10	16	25	35	50	4	6.3	10	16	25	35	50			
Cap (pF) 100	101		-									-		_			_		-			<del></del>			
150	151 221																					<del></del>			
220																									
330 470	331 471		-									_							$\vdash$			$\vdash$			
680	681		-																-			<del>                                     </del>			
1000	102											-					-		-			<u> </u>			
1500	152																					<del></del>			
2200	222																								
3300	332																								
4700																									
6800	682																								
Cap (µF) 0.01	103																								
0.015	150																								
0.022	223																								
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0.047	473																								
0.068	689																								
0.1	104																								
0.15	154																								
0.22	224																								
0.33	334																								
0.47	474					Q	Q							Χ	Х										
0.68	684																								
1.0	105					Q	Q	Q					Χ	Х	Χ										
1.5	155																								
2.2	225			Q	Q	Q	Q	Q					Х	Z	Z										
3.3	335		Q	Q																					
4.7	475	Χ	Х	Х	Х	Х	Х	Х			Z	Z	Z	Z	Z										
10	106	Χ	Х	Х	Х	Х	Х	Χ		Χ	Х	Z	Z	Z	Z					Z					
22	226	Χ	Х	Х	Х	Х			Z	Z	Z	Z	Z			Z	Z	Z	Z						
47	476	Χ	Х	Χ	Х				Z	Z	Z	Z	Z												
100	107	Χ	Х						Z 4	Z												<u> </u>			
Voltage:		4   6.3   10   16   25   35   50								6.3	10	16	25	35	50	4 6.3 10 16 25 35 50									
Case Size					1206							1210				1812									

Letter	Α	В	С	E	G	J	K	М	N	Р	Q	Х	Υ	Z
Max.	0.33	0.22	0.56	0.71	0.90	0.94	1.02	1.27	1.40	1.52	1.78	2.29	2.54	2.79
Thickness	(0.013)	(0.009)	(0.022)	(0.028)	(0.035)	(0.037)	(0.040)	(0.050)	(0.055)	(0.060)	(0.070)	(0.090)	(0.100)	(0.110)
			PA	PER						EMBO	SSED			

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